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Substitution for form 1449A/PTO INFORMATION DISCLOSURE STATEMENT BY APPLICANT <i>(use as many sheets as necessary)</i>				Complete if Known	
				Application Number	10/667,227
				Filing Date	09/18/2003
				First Named Inventor	Jae Hak Yee
				Art Unit	2812
				Examiner Name	Unknown
				Attorney Docket Number	AMKOR012G1
Sheet	1	of	1		

[illegible]

FOREIGN PATENT DOCUMENTS						
Examiner Initials*	Cite No.†	Foreign Patent Document	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear	T8
		Country Code ³ -Number ⁴ -Kind Code ⁵ (if known)				
KR		200204397	08/02/2002	JAPAN		
		0049944	06/26/2002	KOREA		
		2001060648	03/06/2001	JAPAN		
		556398	10/29/2000	JAPAN		
		EP1032037	08/30/2000	EU PAT. OFFICE		
		00150765	05/30/2000	JAPAN		
		EP098968	03/29/2000	EU PAT. OFFICE		
		9967821	12/29/1999	PCT		
KR		9956316	11/04/1999	PCT		
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Examiner Signature	<i>[Signature]</i>	Date Considered	8/25/04
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Approved for use through 10/31/2002. OMB 0651-0031

U.S. Patent and Trademark Office: U.S. DEPARTMENT OF COMMERCE
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RR		100220154	06/18/1999	KOREA		
		10256240	09/25/1998	JAPAN		
		10199934	07/31/1998	JAPAN		
		10163401	06/19/1998	JAPAN		
		EP0844665	05/27/1998	EU PAT. OFFICE		
		10022447	JAN-98	JAPAN		
		9293822	11/11/1997	JAPAN		
		9772358	11/07/1997	KOREA		
		EP0794572A2	10/09/1997	EU PAT. OFFICE		
RR		DE19734794A1	08/11/1997	GERMANY		

Examiner Signature	<i>[Signature]</i>	Date Considered	8/25/04
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INFORMATION DISCLOSURE STATEMENT BY APPLICANT (use as many sheets as necessary)				Application Number	10/667,227
				Filing Date	09/18/2003
				First Named Inventor	Jae Hak Yee
				Art Unit	2812
				Examiner Name	Unknown
				Attorney Docket Number	AMKOR-012G1
Sheet	1	of	1		

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Examiner Initials*	Cite No.†	Foreign Patent Document	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear
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RL		EP0720234	03/07/1996	EU PAT. OFFICE	
		7312405	11/28/1995	JAPAN	
		7297344	11/1995	JAPAN	
		6260532	09/16/1994	JAPAN	
		6140563	05/20/1994	JAPAN	
		692076	04/05/1994	JAPAN	
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				First Named Inventor	Jae Hak Yee
				Art Unit	2812
				Examiner Name	Unknown
Sheet	1	of	1	Attorney Docket Number	AMKOR-012G1

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KE		63249345	10/17/1988	JAPAN		
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		63067762	03/26/1988	JAPAN		
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		6139555	02/25/1986	JAPAN		
		60231349	11/16/1985	JAPAN		
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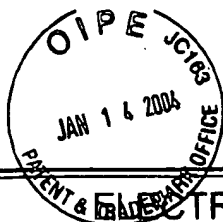
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		59208756	11/27/1984	JAPAN		
		EP5950939	03/19/1984	EU PAT. OFFICE		
		58160095	08/31/1983	JAPAN		
		5745959	03/16/1982	JAPAN		
		55163868	12/20/1980	JAPAN		
KE		EP5421117	06/08/1979	EU PAT. OFFICE		

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ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18
Stylesheet Version v18.0

Title of Invention	SEMICONDUCTOR PACKAGE AND METHOD OF MAKING LEADFRAME HAVING LEAD LOCKS TO SECURE LEADS TO ENCAPSULANT
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Application Number: 10/667227
Confirmation Number: 7012
First Named Applicant: Jae Yee
Attorney Docket Number: AMKOR012G1
Art Unit: 2812



Search string: (5640047 or 5639990 or 5641997 or 5644169
or 5643433 or 5646831 or 5650663 or 5661088
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US Patent Documents

Note: Applicant is not required to submit a paper copy of cited US Patent Documents

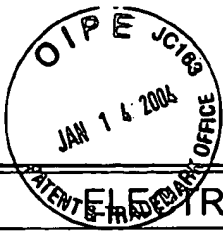
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Signature

Examiner Name	Date
<i>Loi</i>	8/25/04



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First Named Applicant: Jae Yee
Attorney Docket Number: AMKOR012G1
Art Unit: 2812
Search string: (5903049 or 5909053 or 5917242 or 5915998
or 5939779 or 5942794 or 5951305 or 5959356
or 5969426 or 5973388 or 5977630 or 5977615
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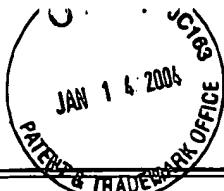
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33	6084310	2000-07-04	MIZUNO ET AL.
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Signature

Examiner Name	Date
<i>K. J. Rose</i>	8/25/04



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TO ENCAPSULANT

Application Number: 10/667227



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First Named Applicant: Jae Yee

Attorney Docket Number: AMKOR012G1

Art Unit: 2812

Search string: (6194777 or 6198171 or 6197615 or 6201292
or 6201186 or 6204554 or 6208023 or 6208021
or 6208020 or 6211462 or 6218731 or 6222258
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US Patent Documents

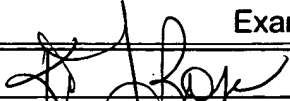
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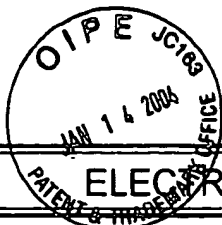
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Signature


Examiner Name	Date
	8/28/04



ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18
Stylesheet Version v18.0

Title of Invention	SEMICONDUCTOR PACKAGE AND METHOD OF MAKING LEADFRAME HAVING LEAD LOCKS TO SECURE LEADS TO ENCAPSULANT
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Application Number: 10/667227 

Confirmation Number: 7012

First Named Applicant: Jae Yee

Attorney Docket Number: AMKOR012G1

Art Unit: 2812

Search string: (6388336 or 6395578 or 6400004 or 6410979
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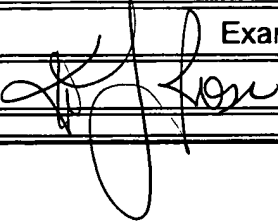
US Patent Documents

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Signature


Examiner Name	Date
	8/25/04



ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18

Stylesheet Version v18.0

Title of Invention	SEMICONDUCTOR PACKAGE AND METHOD OF MAKING USING LEADFRAME HAVING LEAD LOCKS TO SECURE LEADS TO ENCAPSULANT																																																								
<p>Application Number: 10/667227 </p> <p>Confirmation Number: 7012</p> <p>First Named Applicant: Jae Yee</p> <p>Attorney Docket Number: AMKOR012G1</p> <p>Art Unit: 2812</p> <p>Search string: (2596993 or 3435815 or 3734660 or 3838984 or 4054238 or 4189342 or 4258381 or 4289922 or 4301464 or 4332537 or 4417266 or 4451224 or 4530152 or 4541003 or 4646710 or 4707724 or 4727633 or 4737839 or 4756080 or 4812896 or 4862245 or 4862246 or 4907067 or 4920074 or 4935803 or 4942454 or 4987475 or 5018003 or 5029386 or 5041902 or 5057900 or 5059379 or 5065223 or 5070039 or 5087961 or 5091341 or 5096852 or 5118298 or 5151039 or 5157475 or 5157480 or 5168368 or 5172213 or 5172214 or 5175060 or 5200362 or 5200809 or 5214845 or 5216278 or 5218231 or 20010008305 or 20010014538 or 20010011654 or 20020024122 or 20020027297 or 20020140061 or 20020140068 or 20020163015 or 20030030131 or 20030073265).pn.</p>																																																									
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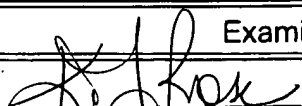
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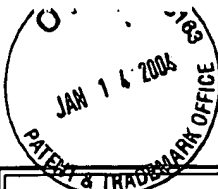
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Note: Applicant is not required to submit a paper copy of cited US Published Applications

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Signature

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ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18

Stylesheet Version v18.0

Title of
Invention

SEMICONDUCTOR PACKAGE AND METHOD OF MAKING
LEADFRAME HAVING LEAD LOCKS TO SECURE LEADS
TO ENCAPSULANT

Application Number: 10/667227



Confirmation Number: 7012

First Named Applicant: Jae Yee

Attorney Docket Number: AMKOR012G1

Art Unit: 2812

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US Patent Documents

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